BOSCH SENSORTEC

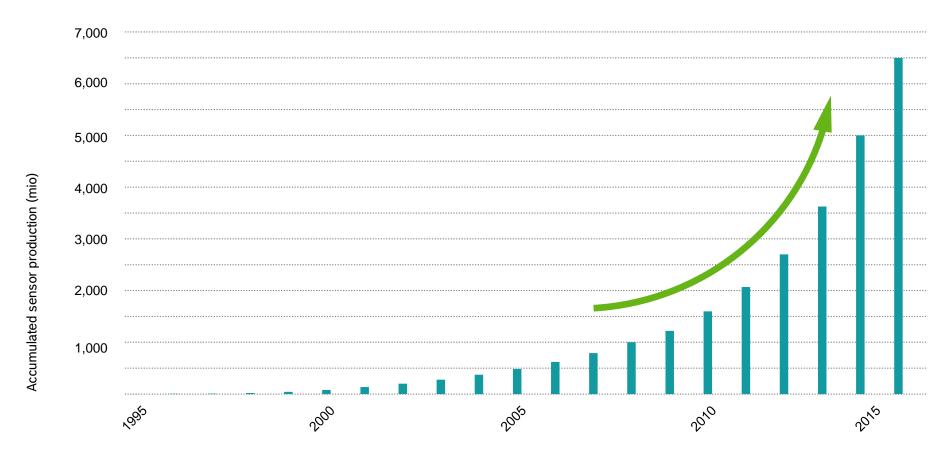
SMART SENSING FOR IOT

JULY 13TH 2016 - SEMICONWEST

FRANÇOIS BEAUCHAUD BOSCH SENSORTEC



Yearly volume increase of MEMS production





Bosch – The MEMS supplier



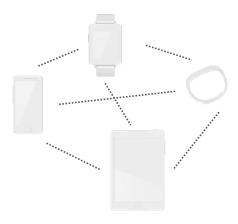
Automotives

- ► Accelerometers
- ► Angular rate sensors
- ► Pressure sensors
- ▶ Mass-flow-sensors



Consumer Electronics

- ► Accelerometers
- ▶ Geomagnetic sensors
- Gyroscopes
- ▶ Pressure sensors
- ► Humidity sensors
- ▶ Combo sensors
- ► ASSNs
- ► MEMS microphones



Internet of Things

- ► Smart sensors / actuator nodes
- ► Embedded SW & algorithms
- Customized IoT sensor & actuator solutions

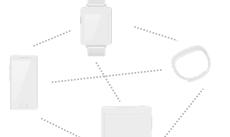


Waves of MEMS sensor proliferation



2nd wave

Consumer Electronics



3rd wave

Internet of Things (IoT)



1st wave

Automotives

1990 2000

2010

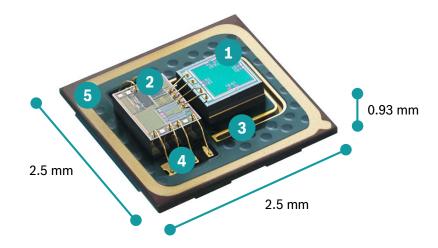
2020



What are MEMS?

Micro-Electro-Mechanical Systems

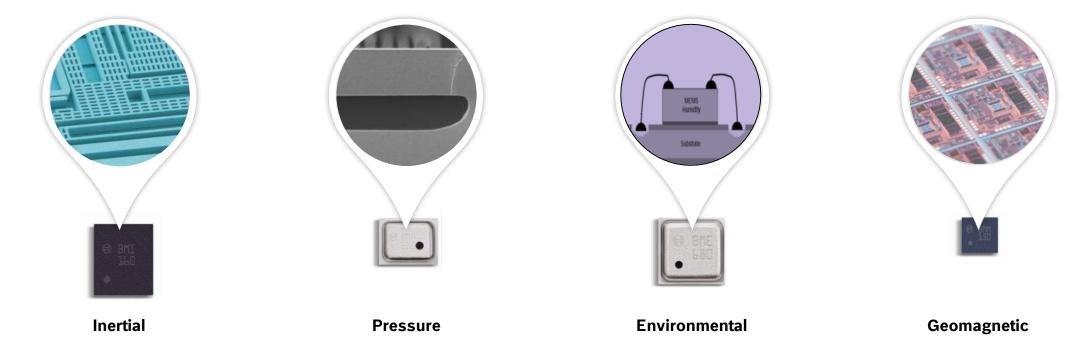
- ► MEMS are miniature systems that combine tiny mechanical structures with electronic circuits. Typical individual structures have a size of a few μm.
- ▶ The MEMS sensor element is usually packaged together with an ASIC and made into one unit, e.g. into a LGA package.



- 1 MEMS
- 2 ASIC
- 3 Decoupling unit
- 4 Bonding wires
- 5 Printed circuit board (PCB)



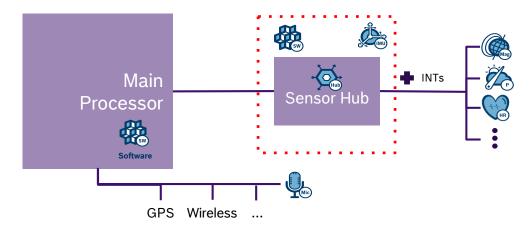
Full Solution Development The Hardware Challenge



Each product segment requires specific technology (not fully CMOS compatible) Challenge for integration, need for advanced packaging technologies (SiP)



Sensors Subsystem Today



Details

- **Sensor Hubs** enable Always-on sensor monitoring in complex systems
- Sensor Fusion is happening at the lowest level
- Sensor types **expending** rapidly (HR, Environmental, ...)
- Sensor subsystems offer the best compromises between flexibility (running on the main processor) and optimization (embedded within the sensor)

- No One-size-fits-all: Each Sensor Subsystem is tailored to its target application
- Processing can be distributed between multiple components of the subsystem depending on the requirements



Sensor Subsystems

Integration of MEMS sensors and MCUs

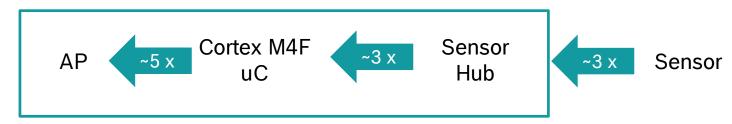
Power efficiency (arrow points to more efficient location)

Optimized Power numbers



Memory cost efficiency (arrow points to more efficient location)

Memory cost efficiency





More use cases than just portrait / landscape

Outdoor



Outdoor

► GPS

Indoor

- ▶ Step count & heading
- ▶ Localization
- ► Improve with pressure

Context



User's context

- ► In a meeting
- ► Outside
- ► Sitting and eating
- ▶ Watching TV
- ► Activity recognition

Fitness



Sports trainer

- ► Step counter
- ▶ Fitness level
- ► Calorie monitoring
- ► Swimming
- ▶ Running
- ▶ Snowboarding
- ▶ Climbing

Wellness



Well-being

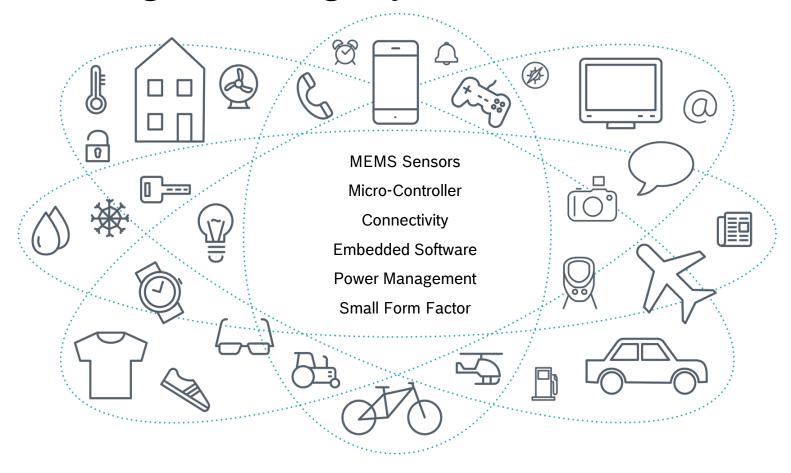
- ► Sleep monitoring
- Activity
- ▶ Socializing

Stress monitoring

- ► Speaker assistant
- ▶ Stress level

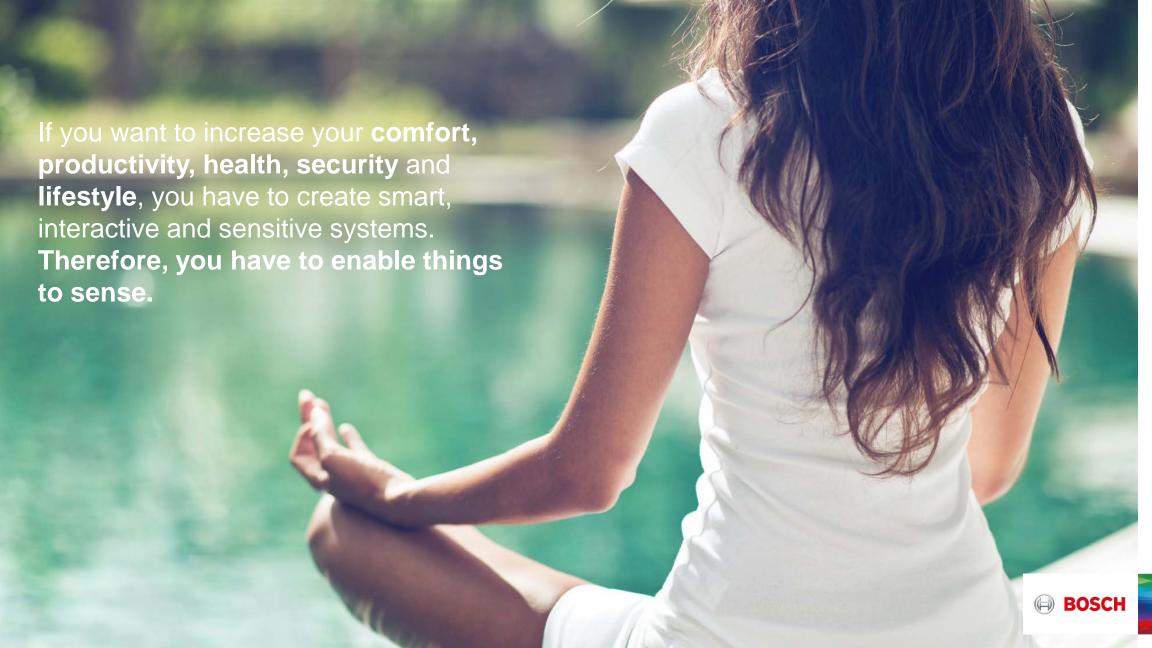


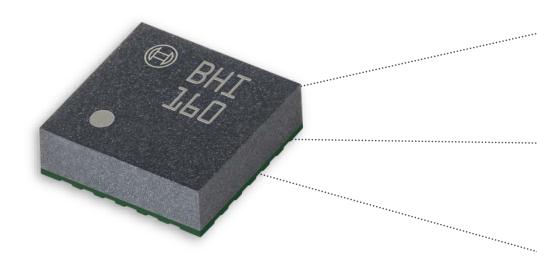
Internet of Things – Making objects smart



Wireless connected smart sensors and actuators are enabling the IoT







MEMS technology

is ready for IoT

Size / power

Continue shrinking of sensor footprint / size and power consumption (e.g. accelerometer)

Integration / µC + SW

Integration of multi-axis sensors + μ C + SW in combo package (e.g. motion / orientation)

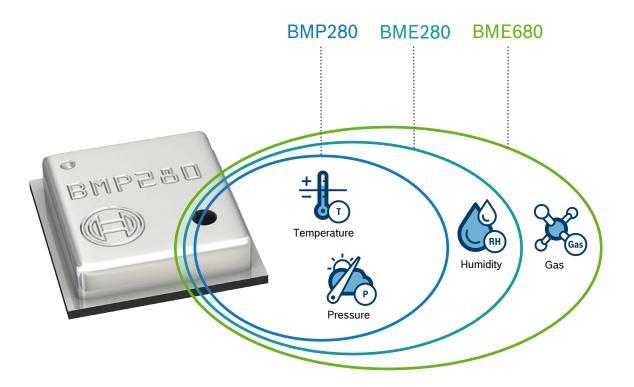
New measurements

Rise / emergence of novel sensor clusters (e.g. environmental cluster – T, p, H, ...)

BOSC

Fast innovation in environmental sensing

Combo sensors: Sensing our environment



New drivers for new applications

Quantify yourself

- ▶ Well-being recommendations
- ► Personalized environment
- ► Sport and fitness monitoring

Personalized control

- ► Environmental monitoring
- ► Personal weather forecast
- ▶ Home automation

Environmental measurement

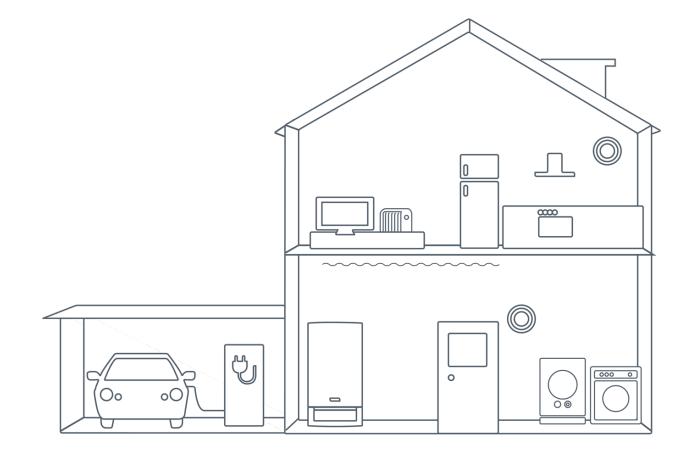
- ► Barometric pressure
- ▶ Humidity
- ▶ Temperature
- ► Gas / indoor air quality



IoT – from monitoring to control

Connected smart, self-enabling sensor networks – integrated within one eco-system via Internet







TODAY, THREE OUT OF FOUR SMART PHONES WORLDWIDE USE BOSCH SENSORTEC SENSORS.

